

- Max $r_{DS(on)}$ = 6.0 m Ω at V_{GS} = 4.5 V, I_D = 21 A
- 100% UIL test
- RoHS Compliant

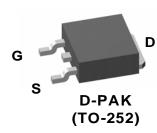


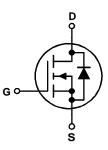
General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$ and fast switching speed.

Applications

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		50		
	-Continuous (Silicon limited)	T _C = 25 °C		131		
ID	-Continuous	T _A = 25 °C	(Note 1a)	27	Α	
	-Pulsed			200		
E _{AS}	Single Pulse Avalanche Energy (Note 3)		(Note 3)	72	mJ	
P _D	Power Dissipation	T _C = 25 °C		65	14/	
	Power Dissipation $T_A = 25 \text{ °C}$ (Note 1a)		(Note 1a)	3.7	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6760A	FDD6760A	D-PAK (TO-252)	13 "	16 mm	2500 units

March 2015

Max	Units
	V
	mV/°C
1	μΑ
±100	nA
3.0	V
	mV/°C
3.2	
6.0	mΩ
4.9	
	S
3170	pF
700	pF

pF

Ω

ns

ns

ns

ns

nC

nC

nC

nC

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$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		16		m
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			1	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1.0	1.6	3.0	1
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-7	-	m
		V _{GS} = 10 V, I _D = 27 A		2.3	3.2	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 21 A		4.4	6.0	,
		V _{GS} = 10 V, I _D = 27 A, T _J = 150 °C		3.5	4.9	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 27 A		186		
Dynamie	c Characteristics					
C _{iss}	Input Capacitance			2380	3170	
C _{oss}	Output Capacitance	V _{DS} = 13 V, V _{GS} = 0 V, f = 1MHz		525	700	
C _{rss}	Reverse Transfer Capacitance			470	710	
Rg	Gate Resistance	f = 1MHz		1.3		
Switchir	ng Characteristics					
t _{d(on)}	Turn-On Delay Time			10	20	
t _r	Rise Time	V _{DD} = 13 V, I _D = 27 A,		9	18	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		28		
t _f	Fall Time			6		
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		44	62	
Q _g	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V} \text{ V}_{DD} = 13 \text{ V},$		25	35	
Q _{gs}	Gate to Source Charge	I _D = 17 A		6		

Test Conditions

 $I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$

Min

25

Тур

Drain-Source Diode Characteristics

Gate to Drain "Miller" Charge

Ven Source to Drain Diode Forward Voltade	Source to Drain Diode, Ferward Voltage	$V_{GS} = 0 V, I_S = 3.1 A$ (N	Note 2)	0.7	1.2	V	
	$V_{GS} = 0 V, I_S = 27 A$ (N	Note 2)	0.8	1.3	v		
t _{rr}	Reverse Recovery Time	I _F = 27A, di/dt = 100 A/μs		21	34	ns	
Q _{rr}	Reverse Recovery Charge	$F_{\rm F} = 27$ A, $u/ul = 100$ A/µs		8	16	nC	

Notes:

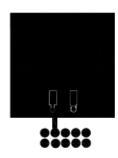
 Q_{gd}

Symbol

BV_{DSS}

Off Characteristics

1: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.

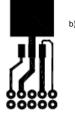


Electrical Characteristics T_J = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

a) 40 °C/W when mounted on a 1 in² pad of 2 oz copper



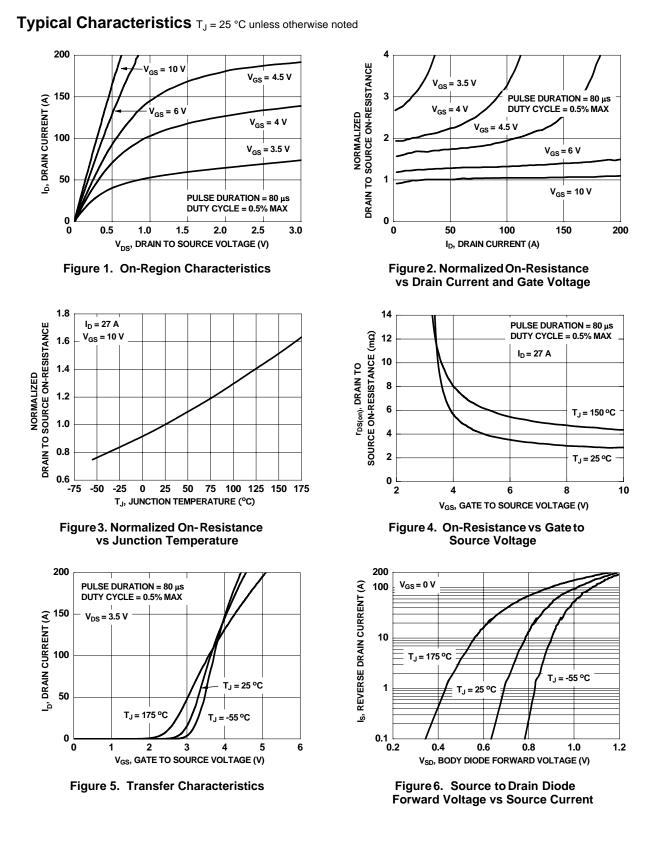
b) 96 °C/W when mounted on a minimum pad.

9.9

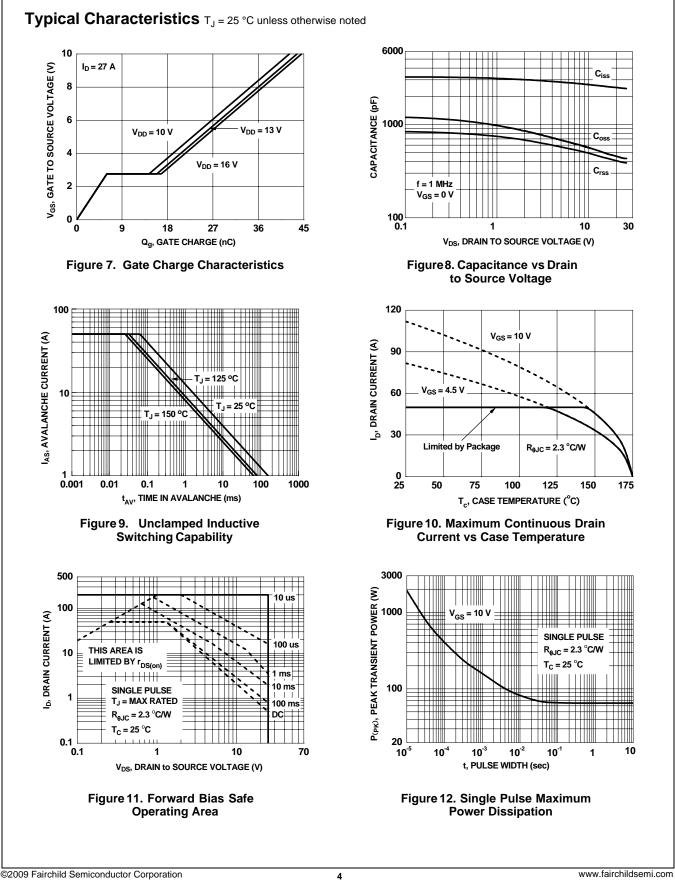
2: Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. **3:** E_{AS} of 72 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 12 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 29 A.

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FDD6760A N-Channel Power Trench[®] MOSFET

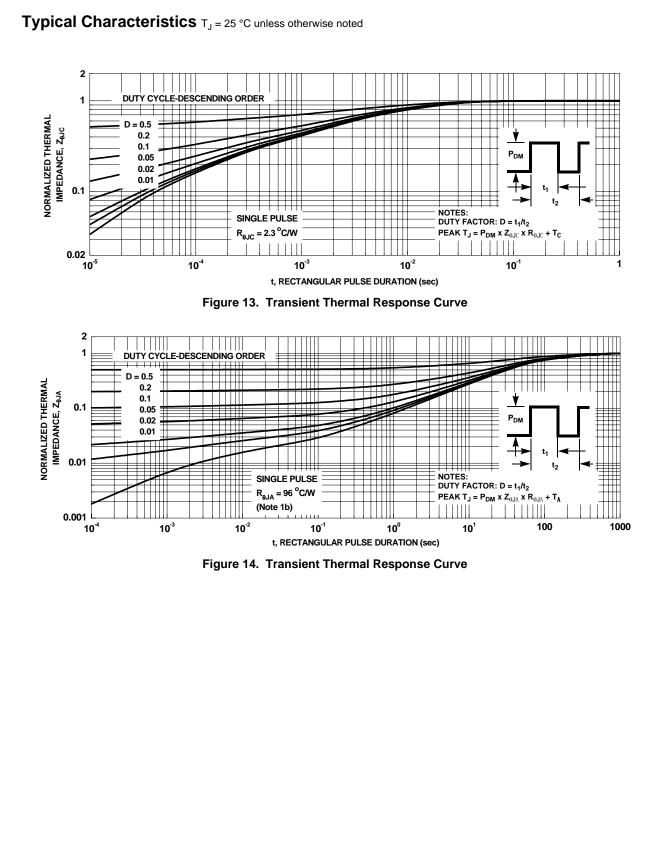


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